



APPLICATION FOR UNITED STATES PATENT  
Declaration for Patent Application

3  
E6035-01 \*

As a person named inventor, I hereby declare that:

My residence, office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the

invention entitled: 1 "NON-AQUEOUS ELECTROCHEMICAL APPARATUS"  
the specification of which 2 (file no. \_\_\_\_\_)  
(check at least one) 3 [ ] is attached hereto

4 [X] was filed on July 10, '01 as (5) U.S. Application Serial No. 09/901, 130

6 [ ] and was amended on \_\_\_\_\_  
(if applicable)

|                                                                                       |       |                                                   |
|---------------------------------------------------------------------------------------|-------|---------------------------------------------------|
| Use this portion<br>Only if you are<br>entering the U.S.                              | 7 [ ] | was filed as PCT international application        |
| National phase based<br>on a PCT International<br>Application designating<br>the U.S. | 8     | Number _____                                      |
|                                                                                       | 9     | on _____                                          |
|                                                                                       | 10    | and was amended under PCT Article(s) 19 and/or 34 |
|                                                                                       |       | on _____ (if applicable).                         |

I hereby declare that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended, by any amendment referred to above.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me which is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 or 365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date earlier than that of the application(s) on which priority is claimed.

Prior (Foreign) Application(s) any Priority Claims Under 35 U.S.C. 119 or 365 Priority Claimed

|     |                           |                                |                                                |                   |
|-----|---------------------------|--------------------------------|------------------------------------------------|-------------------|
| 11a | <u>Japan</u><br>(Country) | <u>2000-215518</u><br>(Number) | <u>17 July, 2000</u><br>(Day/Month/Year Filed) | [X] [ ]<br>Yes No |
|     | <u>Japan</u><br>(Country) | <u>2000-215519</u><br>(Number) | <u>17 July, 2000</u><br>(Day/Month/Year Filed) | [X] [ ]<br>Yes No |
|     | <u>Japan</u><br>(Country) | <u>2000-215520</u><br>(Number) | <u>17 July, 2000</u><br>(Day/Month/Year Filed) | [X] [ ]<br>Yes No |

[ ] Additional foreign application numbers are listed on a supplemental priority data sheet attached hereto.

Priority Claim(s) from U.S. Provisional Application(s) - I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:

|     |                                                                                                                  |                      |                 |                      |
|-----|------------------------------------------------------------------------------------------------------------------|----------------------|-----------------|----------------------|
| 11b | Application No.                                                                                                  | Day/Month/Year Filed | Application No. | Day/Month/Year Filed |
|     | [ ] Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto. |                      |                 |                      |

|                                                                                                                                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                                   |                                                            |
|--------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|------------------------------------------------------------|
| Do not use this<br>portion to identify<br>a PCT application<br>if the parent<br>application is the<br>U.S. National<br>phase of the PCT<br>application | I hereby claim the benefit under Title 35, United States Code, 120 of any United States application(s) or under Title 35, United States Code, 365 of any PCT international application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between filing date of the prior application and the national or PCT international filing date of this application. |                                                   |                                                            |
|                                                                                                                                                        | 12                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | (U.S. Parent Application<br>or PCT Parent Number) | (Parent Filing Date) Status (patented, pending, abandoned) |
|                                                                                                                                                        | [ ] Additional U.S. or PCT international application numbers are listed on a supplemental priority data sheet attached hereto.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                                   |                                                            |

I hereby appoint the following attorneys of the firm of Stevens, Davis, Miller & Mosher, L.L.P. as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the Patent and Trademark Office: James E. Ledbetter, Reg. No. 28732; Thomas P. Pavelko, Reg. No. 31689; and Anthony P. Venturino, Reg. No. 31674.

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO STEVENS, DAVIS, MILLER & MOSHER, L.L.P., 1615 L Street, N.W., Suite 850, Washington, D.C. 20036, TELEPHONE (202) 408-5100, FACSIMILE (202) 408-5200.

6035-01 (※)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful statements may jeopardize the validity of the application or any patent issuing thereon.

|     |                                                                             |            |                                                                          |                           |
|-----|-----------------------------------------------------------------------------|------------|--------------------------------------------------------------------------|---------------------------|
| 13a | Typewritten Full Name of Sole or First Inventor                             |            | <u>Kazuya IWAMOTO</u>                                                    |                           |
|     |                                                                             | Given Name | <del>XXXXXXXX</del>                                                      | Family Name               |
| 14a | Inventor's Signature                                                        | Λ          | <u>Kazuya Iwamoto</u>                                                    |                           |
| 15a | Date of Signature                                                           | Λ          | <u>September 10, 2001</u>                                                |                           |
|     |                                                                             |            | Month                                                                    | Day Year                  |
| 16a | Residence                                                                   |            | <u>Sakai-shi, Japan</u>                                                  |                           |
|     |                                                                             |            | City                                                                     | State or Province Country |
| 17a | Citizenship                                                                 |            | <u>Japan</u>                                                             |                           |
| 18a | Post Office Address<br>(Insert complete mailing address, including country) |            | <u>2-19-20, Ebarajicho, Sakai-shi, Osaka, Japan.</u>                     |                           |
| 13b | Typewritten Full Name of Second Inventor                                    |            | <u>Takafumi OURA</u>                                                     |                           |
|     |                                                                             | Given Name | <del>XXXXXXXX</del>                                                      | Family Name               |
| 14b | Inventor's Signature                                                        | Λ          | <u>Takafumi Oura</u>                                                     |                           |
| 15b | Date of Signature                                                           | Λ          | <u>September 10, 2001</u>                                                |                           |
|     |                                                                             |            | Month                                                                    | Day Year                  |
| 16b | Residence                                                                   |            | <u>Hirakata-shi, Japan</u>                                               |                           |
|     |                                                                             |            | City                                                                     | State or Province Country |
| 17b | Citizenship                                                                 |            | <u>Japan</u>                                                             |                           |
| 18b | Post Office Address<br>(Insert complete mailing address, including country) |            | <u>46-3-208, Yamadaike Higashimachi,<br/>Hirakata-shi, Osaka, Japan.</u> |                           |
| 13c | Typewritten Full Name of Third Inventor                                     |            | <u>Kumiko SONODA</u>                                                     |                           |
|     |                                                                             | Given Name | <del>XXXXXXXX</del>                                                      | Family Name               |
| 14c | Inventor's Signature                                                        | Λ          | <u>Kumiko Sonoda</u>                                                     |                           |
| 15c | Date of Signature                                                           | Λ          | <u>September 10, 2001</u>                                                |                           |
|     |                                                                             |            | Month                                                                    | Day Year                  |
| 16c | Residence                                                                   |            | <u>Hirakata-shi, Japan</u>                                               |                           |
|     |                                                                             |            | City                                                                     | State or Province Country |
| 17c | Citizenship                                                                 |            | <u>Japan</u>                                                             |                           |
| 18c | Post Office Address<br>(Insert complete mailing address, including country) |            | <u>7-85, Ikaga Kitamachi, Hirakata-shi,<br/>Osaka, Japan.</u>            |                           |

\*Note to Inventor: Please sign name on line 14 exactly as it appears in line 13 and insert the actual date of signing on line 15. If there are more than four inventors, please add a copy of this page for identification and signatures for the additional inventors.

13d Typewritten Full Name of Fourth Inventor Makino HATAZAKI  
 Given Name XXXX XXXX Family Name

14d Inventor's Signature  $\wedge$  Makino Hatazaki

15d Date of Signature  $\wedge$  September 10, 2001  
 Month Day Year

16d Residence Osaka-shi, Japan  
 City State or Province Country

17c Citizenship Japan

18d Post Office Address (Insert complete mailing address, including country)  
2-21-18, Omiya, Asahi-ku, Osaka-shi,  
Osaka, Japan.

13e Typewritten Full Name of Fifth Inventor Hiroshi YOSHIZAWA  
 Given Name XXXX XXXX Family Name

14e Inventor's Signature  $\wedge$  Hiroshi Yoshizawa

15e Date of Signature  $\wedge$  September 10, 2001  
 Month Day Year

16e Residence Hirakata-shi, Japan  
 City State or Province Country

17c Citizenship Japan

18e Post Office Address (Insert complete mailing address, including country)  
22-5-506, Fujisaka Kitamachi, Hirakata-shi,  
Osaka, Japan.

13f Typewritten Full Name of Sixth Inventor Shinji NAKANISHI  
 Given Name XXXX XXXX Family Name

14f Inventor's Signature  $\wedge$  Shinji Nakanishi

15f Date of Signature  $\wedge$  September 10, 2001  
 Month Day Year

16f Residence Hirakata-shi, Japan  
 City State or Province Country

17c Citizenship Japan

18f Post Office Address (Insert complete mailing address, including country)  
1-12-5-509, Machikuzuba, Hirakata-shi,  
Osaka, Japan.

\*Note to Inventor: Please sign name on line 14 exactly as it appears in line 13 and insert the actual date of signing on line 15. If there are more than four inventors, please add a copy of this page for identification and signatures for the additional inventors.